



# Status and prospects of the ALICE Inner Tracking System

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### Inner Tracking System of the ALICE experiment





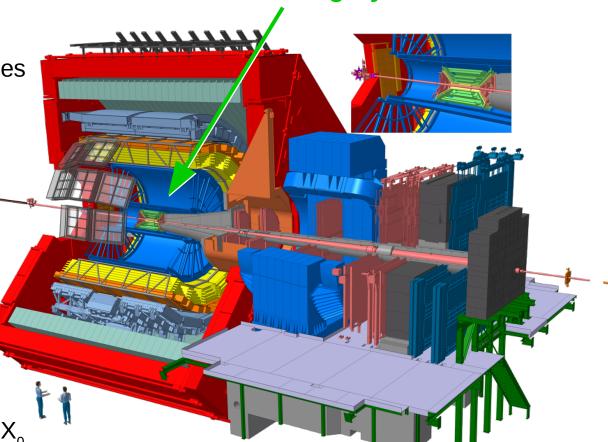
**Inner Tracking System** 

1) primary vertex reconstruction

2) reconstruction of secondary vertices

### Old ITS1:

- 6 silicon detector layers:
  - 2 Silicon Pixel (SPD)
  - 2 Silicon Drift (SDD)
  - 2 Silicon Strip (SSD)
- Readout rate: ~1 kHz
- Material budget per layer 1.14 % X<sub>0</sub>



# Motivation for the ITS upgrade

# ALTCE

### **ALICE physics goals for Run 3**

- vector mesons and low-mass di-leptons chiral-symmetry restoration, virtual thermal photons from the quark-gluon plasma (QGP)
- open heavy flavor hadrons and quarkonia down to zero  $p_T$  thermalization, hadronization, recombination, temperature evolution of the QGP



J.Phys. G41 (2014) 087001

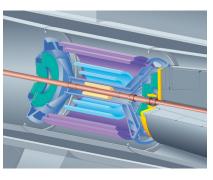
• high-precision measurement of light (anti-)nuclei and hypernuclei nucleosynthesis, exotics

### **Main ITS2 upgrade requirements**

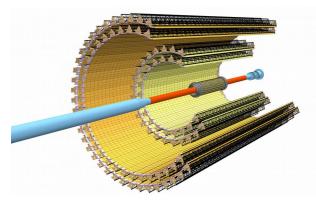
- continuous read-out to fully exploit 50 kHz Pb-Pb interaction rate
- improved tracking performance down to very low  $p_{\scriptscriptstyle 
  m T}$

## **Evolution of the ITS**

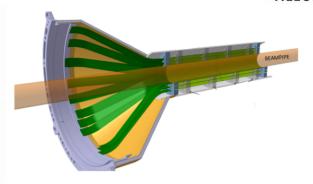




ITS1



ITS2

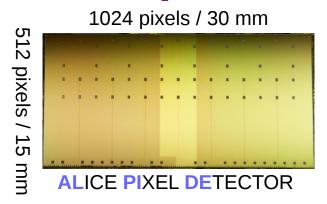


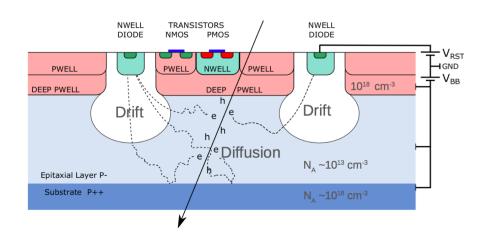
ITS3

Design	6 layers SPD, SDD, SSP	7 layers of ALPIDE Monolithic Active Pixel Sensor (MAPS)	IB is replaced by a cylindrical structure from bent MAPS
Material budget per layer	1.14 % X <sub>0</sub>	0.3 % X <sub>o</sub> Inner Barrel (IB), 1 % X <sub>o</sub> Outer Barrel (OB)	0.02 – 0.04 % X <sub>0</sub>
Radial position of the first layer	39 mm	23 mm	18 mm
Period of operation	Till 2021 Run 1+2	2022 – 2030 Run 3+4	2027 – 2030 Run 4

# **ALPIDE** pixel sensor







#### **Monolitic Active Pixel Sensor ALPIDE**

180 nm CMOS imaging process by TowerJazz

Pixel pitch 29  $\mu$ m × 27  $\mu$ m

Power consumption < 40 mW cm<sup>-2</sup>

Detection efficiency > 99 %

Fake-hit rate < 10<sup>-6</sup> /hits/cm<sup>2</sup>

Ability to mask pixels

Radiation load for the Inner Barrel\* (ALPIDE sensors required to sustain 10x larger radiation load)

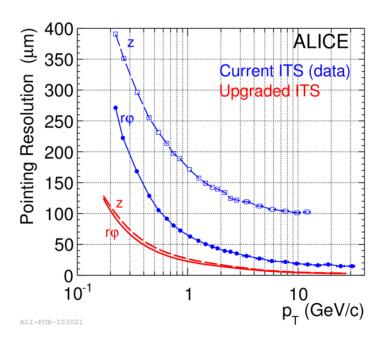
Total Ionizing Dose: 270 krad

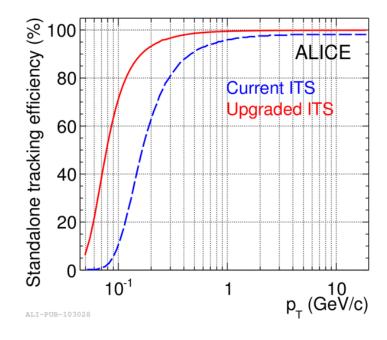
**N**onlonizing Energy Losses ~ 1.7  $10^{12}$  1 MeV  $n_{eq}$  cm<sup>-2</sup>

[\*] J. Phys. G 41 (2014) 087002

# **Designed performance of ITS2**







Position resolution will be improved by

- 6 times in z direction for  $p_{\tau} < 1 \text{ GeV/}c$
- 3 times in  $r\varphi$  direction for  $p_{\tau} < 1 \text{ GeV/}c$

ITS standalone tracking efficiency will be significantly increased below  $p_{\scriptscriptstyle T} < 1~{\rm GeV}/c$ 

General timeline of the upgrade

**2011:** Start of the ALPIDE sensor R&D

**December 2016:** Sensor and modules production started

May 2019: Begining of the ITS commissioning in on-surface laboratory:

- Threshold scans
- Tests of noise performance
- Measurements of temperature and current
- Cosmic runs

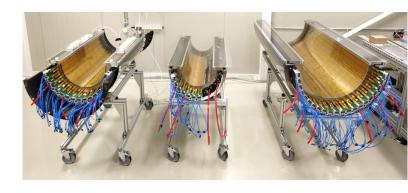
January 2021: Start of the ITS installation in the ALICE cavern

July 2021: Global commissioning

October 2021: Pilot beam test



Module Assembly Machine

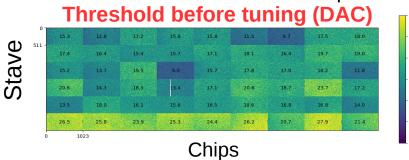


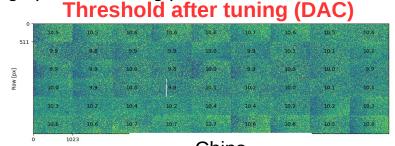
OB in the on-surface laboratory

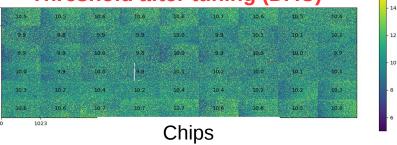
# ITS on-surface commissioning



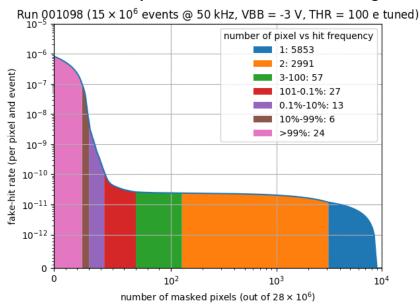
Uniform level of the threshold for all chips after choosing optimal working parameters



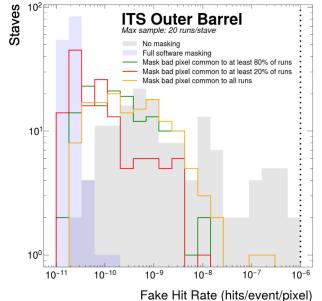




Fake-hit rate  $\sim 10^{-10}$  /pixel /event after masking out noisy pixels (**Project goal is 10**-6 /pixel /event)

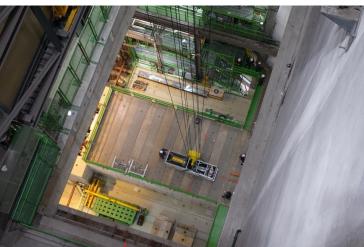


Artem Isakov



# ITS installation in ALICE cavern



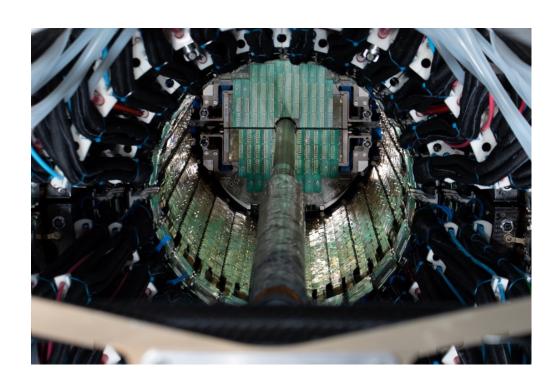




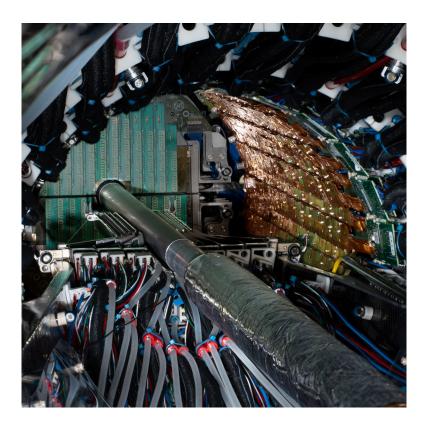


# ITS installation in ALICE cavern





Installed OB



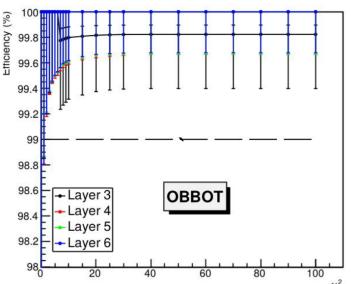
OB + bottom half-barrel of the IB

# ITS Commissioning in the cavern

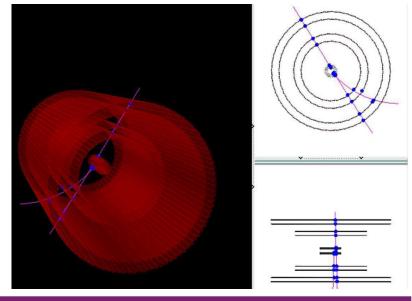


- Test of system connectivity and stability
- Test of Detector Control System and quality control
- First data taking with the complete detector
- Analysis of the first cosmic muon tracks

### **Tracking efficiency of comsic particles**



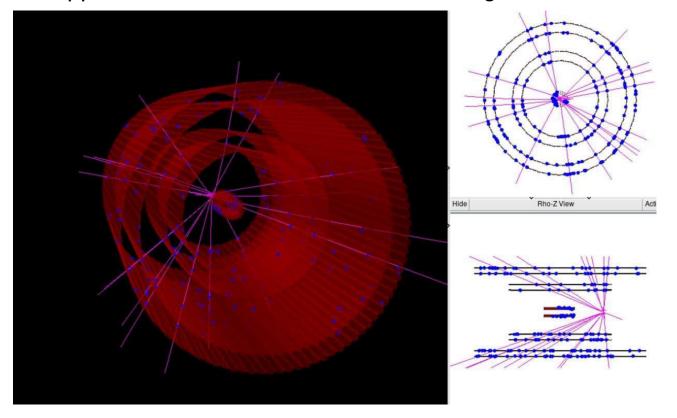
#### **Example of a cosmic ray**



# ITS pilot beam results



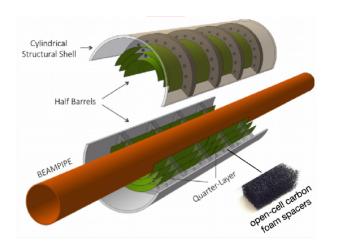
**October pilot beam:** pp collisions at  $\sqrt{s}$  = 900 GeV, 0.2 T magnetic field



Detector and software successfully performed the first reconstruction of pp data

### IB of the ITS3 vs ITS2



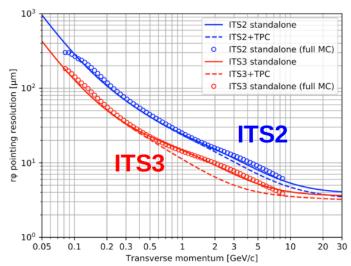


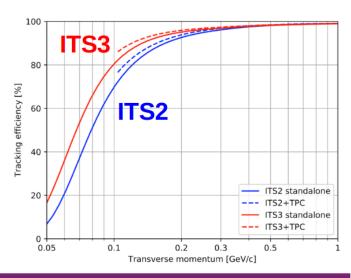


### **Changes with respect to the ITS2:**

- Chip dimensions: 1.5 cm x 3 cm → 28 cm x 10 cm
- Silicon thickness: 50 µm → 20-40 µm
- Power consumption: 40 mW/cm<sup>2</sup> → 20 mW/cm<sup>2</sup>
- Pixel size: 27 x 29  $\mu$ m  $\rightarrow$  10 x 10  $\mu$ m
- Time resolution:  $1 \mu s \rightarrow 100 \text{ ns}$
- NIEL radiation tolerance:  $3 \times 10^{13} \rightarrow 3 \times 10^{14} \text{ 1 MeV } n_{eq}/\text{cm}^2$
- TID radiation tolerance: 3 Mrad → 10 Mrad

Result: better tracking performance especially at low  $p_{\tau}$ 

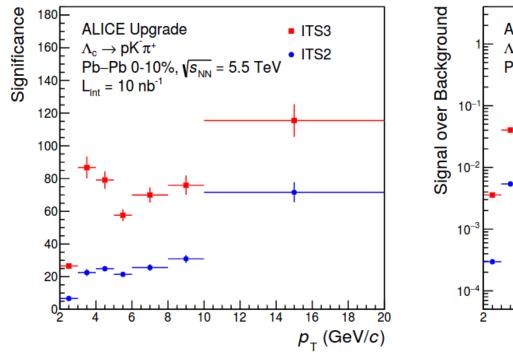


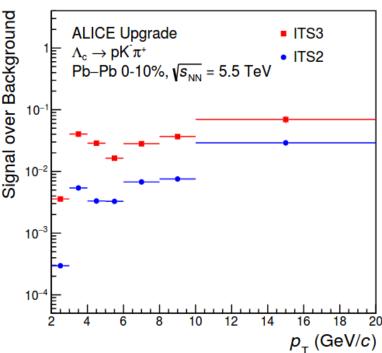


# **ITS3** performance



The improved impact parameter resolution and the reduced material budget of the ITS3 will significantly improve the performance of the heavy-flavour reconstruction [\*]:

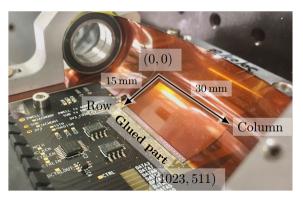


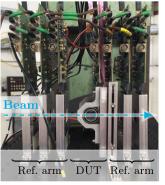


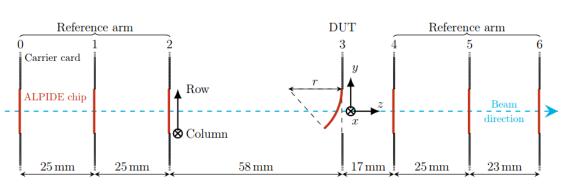
[\*] Letter of Intent for an ALICE ITS Upgrade in LS3, CERN-LHCC-2019-018; LHCC-I-034

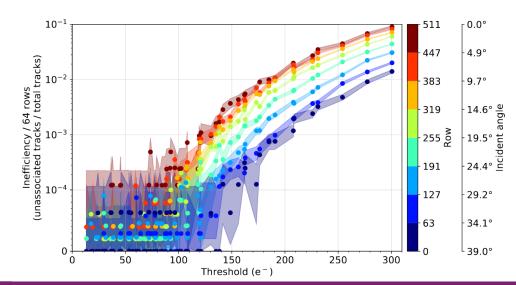
## **Test of the bent ALPIDE**











- Tested on 5.4 GeV electron beam
- Tracking done with ALPIDE telescope
- 99% trackig efficiency for default parameters

# **Summary**



- On-surface ITS commissioning showed detector stability and confirmed compliance with the upgrade project goals.
- ITS2 was fully installed in the ALICE cavern.
- ITS2 performance was verified in pilot beams and global commissioning.
- ITS3 bent chip R&D is ongoing.



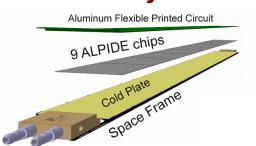
# Backup

# **ITS2 layout**



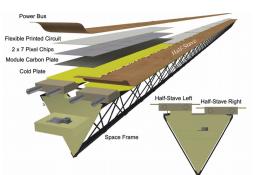
### 1 – 3 Layer: Inner Barrel Stave

4 – 7 Layer: Outer Barrel Stave



- Length: 270 mm
- Sensor thickness: **50 μm**
- Material budget: ~ 0.3 % X<sub>0</sub>
- Readout speed: 1200 Mbps

- 7 layers (inner/middle/outer): 3/2/2
- 192 staves (inner/middle/outer): 48/54/90
- 10 m<sup>2</sup> active silicon area
- 12.5×10<sup>9</sup> pixels



- Split into two half staves
- Length: 844 mm (middle layer),1475 mm (outer layer)
- Sensor thickness: 100 μm
- Material budget: ~ 1 % X<sub>0</sub>
- Readout speed: 400 Mbps